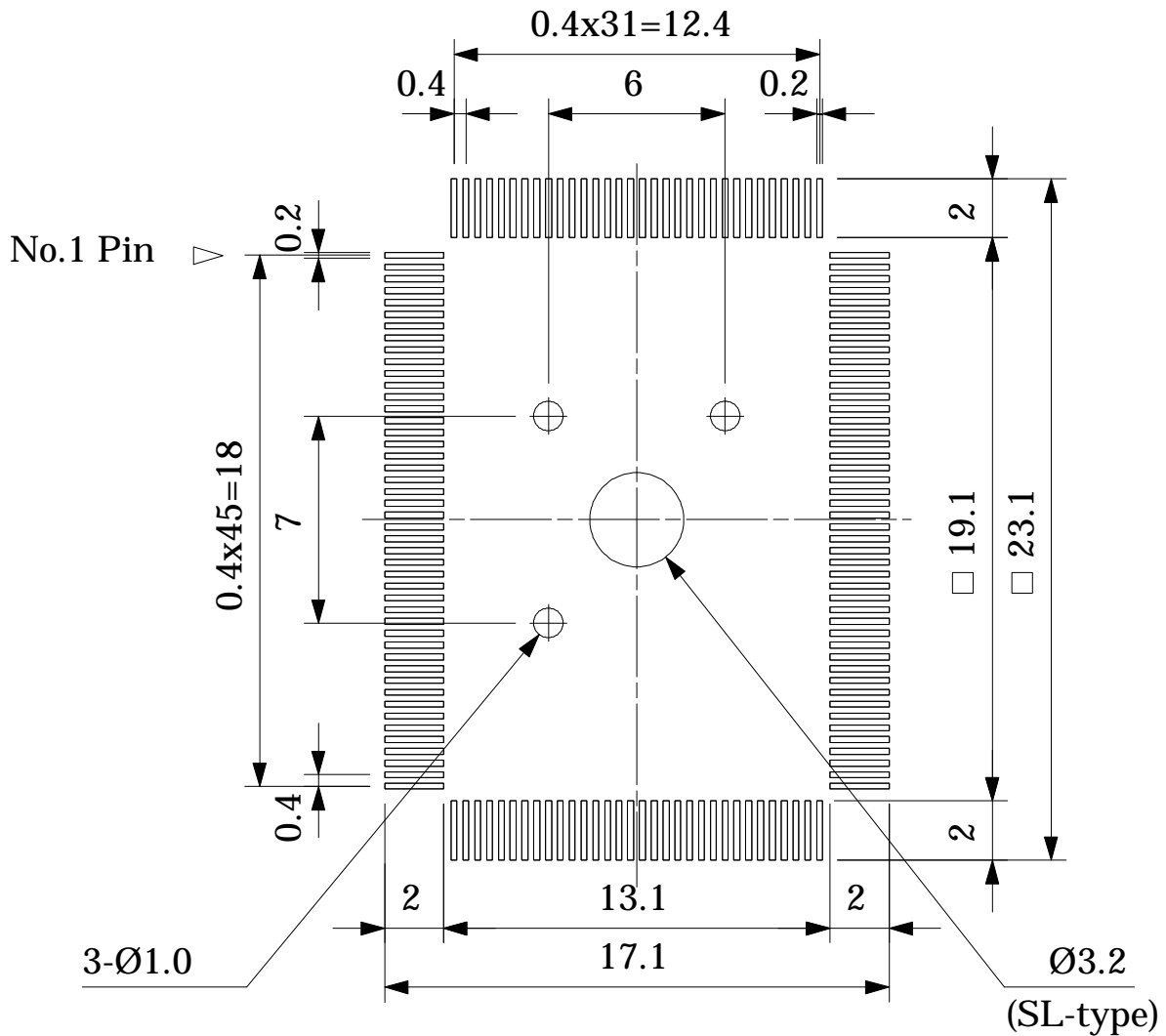


Recommended a Footprint pattern of NQPACK156RE



\* Recommended foot pattern shown on left is for NQPACK soldering.  
 But please refer to IC package foot pattern recommended by IC manufacturer  
 also, when the package is soldered on the same foot pattern.

Part No.	<b>NQPACK156RE</b>
IC package	Rectangle
Pin count	156in
Lead pitch	0.4mm
Unit : mm	Design : M.H
<b>TET</b> TOKYO ELETECH CORP.	